Customer:

No. SW065124A

Date: 2006 - 07 - 20

ALPS EUROPE DISTRIBUTION

Attention:

Your ref. No. :

Your Part No.: \$PPH110800

SPECIFICATION

ALPS';

MODEL: STSPPH11

Spec. No.: SPPH-S-501

Sample No.: F3290243M

RECE	EIPT STATUS
RECE	EIVED
Ву	Date
	Signature
,	Name
,	Title



K.
DSG'D Tomita

APP'D K.ITO
ENG. DEPT. DIVISION

Sales

Head Office 1-7, Yukigaya-otsuka-cho, Ota-ku, Tokyo. 145-8501 Japan Phone. +81(3)3726-1211

	·		(Pus
S!	PPH-S-501	SPPH 1 PRODUCT SPECIFICATIONS	
1.1 1.2 1.3	2 Operating temperatu 3 Test conditions	specification is applied to low current circuit (Secondary circuit) pusure range: -10 ~ 60°C The standard test conditions shall be 5~35°C in temperature. 45~85% RH atmospheric pressure. Should any doubt erise in judgement, tests shall be 56~106kPa 1850-1960charlotten and dimensions a shall have good finishing, and shall have no rust, crack or plating fa	and 86~100kPa 1888—1888—1888 and e conducted at 20±2°C, 65±5% RH and
2.3 2.3 3. F	2 Construction and di 3 Harkings Per indi	lmensions Per individual product drawing vidual product drawing	iures.
	Items	Test conditions	Criterion
4.1	Contact resistance	Shall be measured at 1kHz±200Hz (20mV MAX , 50mA MAX) or 1A, 5V DC by voltage drop mathod.	2O mΩ HAX
4.2	Insulation resistance	Test voltage: <u>500</u> V DC, measured after 1 minute±5 seconds. Applied position: Between all terminals Between terminals and ground (frame)	10Q HQ HIH
4.3	Voltage proof	Test voltage: 500 V AC (50~80Hz, cut-off current 2 nA) Applied position: Between all terminals Duration: minute Between terminals and ground (frame)	No dielectric breakdown shall occur.
4.4	Capacitance .	Shall be measured at 1MHz ± 10kHz Between all terminals Between terminals and ground (frame) Between all circuits	1.5. pP KAX
4.5	Changeover timing		As per individual product drawing,
5. M	echanical performanc	0	
5.1	Items Operating force	Test conditions A static load shall be applied to the tip of actuator in operating	Criterion As per individual product drawing.
5.2	Terminal strength	A static load of 5 H = 5 10 met Ashall be applied to the tip of terminal in a desired direction for 1 minute. The number of test shall be once per terminal.	Shall be free from terminal looseness and damage and breakage of terminal holding portion. Terminals may be bent after test, electrical performance requirement specified in item 4 shall
5.3	Hounting strength	Thread shall be sounted at Hen (kgf ca) by normal sounding sating.	be satisfied. Shall be free from damage of thread
5.4	Control strength 5.4.1 Control strength	(1) A static load of 50N 451-4mf/Apail be applied in the operating direction of actuator for 15 seconds. (2) A static load of 30 K 4306-4mf/Apail be applied in the pull direction of actuator for 15 seconds. (3) For construction with lock, the test shall be conducted at the condition of lock released.) (4) A static load of 10N florest Apail be applied to the vertical direction of operation at the tip of actuator for 15 seconds.	Shall be free from pronounced wobble, bending and mechanical abnormalities.
	5.4.2 Lock hold- ing strength of actuator (Applied to the switch with lock mechanism)	(1) A static load of	Lock shall not be dislocated. Shall be free from pronounced wobble and abnormalities in operation.
5.5	1	Run-out (P-P) shall be measured by applying a static load of 1N (162st) in the vertical direction of operation at the tip of actuator.	P-P :1 ma HAX
5.0	Roy of actuator (Applied to multipul-key push switch)	Switch shall be mounted as shown. Difference of sides shall be measured.	Difference between actuators t: = Vithin
	-51	# 10 11 11, 19 Appl. CHKD. DSGD. # 10 11 11, 19 Appl. CHKD. DSGD. Jun. 1	.93 TITLE
	SPPHI	GROUND PAGE SYMB DATE APPD CHRD DSGD Kisca Thebahi Umaga	DRAVING NO.
(49)	ALPS FLECTRIC CO.	I TD	

			(P
SPP	H-S-501	SPPH 1 PRODUCT SPECIFICATIONS	
Т	Items	Test conditions	Criterion
7	lounting frame	Both ends of mounting frame shall be secured. A static load of	Very on mounting frame shall be Q
	treath	N. (kxf) shall be applied to the center of apunting frame	max. Shall be free from absermalit
	(Applied to sulti-	In A. B. C and D directions each 15 seconds.	in operation.
	pul-key push switch)		
	earron)	C C	
- 1		\ \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	1
	•		•
			i
		ð c	1
		l vulu	·
			_
- 1		Pixed Pixed	
- 1			
- [
_		' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' '	
8 V	ibration	Switch shall be secured to a testing machine by a regular mounting	Contact resistance (Item 4.1) :
l		device and method.	20 an NAX
-		(1) Vibration frequency range: 10~55Hz	Insulation resistance (Item 4.2) :
-		(2) Total amplitude: 1.5mm	100 NO NIN
		(3) Sweep ratio: 10-55-10(Hz) Approx. 1 minute (4) Mathod of changing the sweep vibration frequency: Logarithmic or	Voltage proof (Item 4.3): Apply 500 V AC for 1 minute.
ſ		linear linear	Ro dielectric breakdown shall oc
		(5) Direction of vibration : Three vertical directions	Operating force (Item 5.1) :
		Including actuator.	Vithin ±18 x of specified value
		(6) Time : 2 hours each (6 hours in total)	No abnormalities shall be recognize
9 K	echanical shock	Switch shall be accounted after following test.	in appearance and construction. Contact resistance (Item 4.1):
	5.9.1 Mechanical	(1) Hounting method : Hormal mounting method	20 mg MAX
	shock	(2) Acceleration: 490m/s ² (-505-)/2	Operating force (Item 5.1)
		(3) Duration: 11ms	Vithin <u>±18</u> x of specified valu
- 1		(4) Test direction : 8 directions	Shall be free from mechanical
		(5) Humber of shock : 3 times per direction	abnormalities. Dislocation of lock of actuator a
L		(18 times in total)	not be regarded as abnormalities.)
5	.9.2 Lock holding	Switch shall be conducted at the condition of locking actuator.	Lock of actuator shall not be dis-
ı	shock (Applied to the	(1) Acceleration: 147x/e ² (150)A (2) Duration: 11 as	located. Shall be free from
ľ	switch with lock	(3) Test direction: 6 directions	abnormalities in operation.
- 1	mechanism.)		
- [•	(4) Humber of shock : 3 times par direction	
		(18 times in total)	
LO S	olderability	Switch shall be checked after following test.	Hore than 90% of immersed part shall
- 1		(1) Solder : M63A (JIS Z 3282) (2) Flux : Resin flux (JIS K 5902) having a nominal composition of 25%	be covered with solder.
- 1		solids by weight of water white rosin in methyl alcohol	
- [(JIS K 1501) solution.	
j	ļ	(3) Soldering temperature : 230±5°C	
	ļ	Innersing time: 3±0.5 s	
		Flux immersing time shall be 5~10 seconds in normal temperature. (4) Immersion depth: Immersion depth shall be at copper plating	
- [portion for P.C.B. terminal after mounting.	
- 1		Thickness of P.C. board : 1.6 mm	
	l	Immersion depth shall be at wiring portion of	
11 5	oldering heat	lead wire for lead wire terminal. Switch shall be measured after following test.	He share allowed the second
	esistance	(1) Solder: H63A (JIS Z 3282)	Ho abnormalities shall be recognize in appearance. The electrical perfo
		(2) Flux : Rosin flux (JIS & 5992) having a nominal composition of 10%	ance requirements specified in item
		solids by weight of water white resin in methyl alcohol	shall be satisfied.
		(JIS K 1501) solution.	
		(3) Temperature and immersing time	
-	1	Temperature (C) Time (s)	
		Automatic soldering 250±5 10±1	·
		Namual soldering 350±10 3+1	
	I	APPD. CHKD. DSGD.	TITLE
		M. g. Jun.1	. 9 3
		PAGE SYNB DATE APPD CHIKO DSGD L: 3 - Thelash Unice	DRAVING HO.

:<u>:</u> .

SP	PH-5-501	SPPH1 PRODUCT SPECIFICATIONS	
		·	
	Items	. Test conditions	Criterion
		(4) Immersion depth : Immersion depth shall be at copper plating	
		portion for P.C.B. terminal after mounting.	
		Thickness of P.C. board (Single sided copper	·
	f	clad P.C.B.) :-1.6mm	<u>,</u>
		Immersion depth shall be at wiring portion of	•
5.12	Resistance to flux	lead vire for lead vire terminal.	
1.16	(Applied to the	Switch shall be checked after following test. (1) Equipment : Auto-dip chasher	Flux shall not be risen up to contact
	switch for P.C.	(2) Solder: H83A (JIS 2 3282)	Shall be free from abnormalities in
	board)	(3) Flux: Rosin flux (JIS K 5902) having a nominal composition of 25%	operation.
	5041 47	solids by weight of water white resin in methyl alcohol	
	·	(JIS K 1501) solution.	
		(4) Temperature : 260±5°C	
		(5) Inxersing time : 5±1 s	
		(6) Immersion depth : Immersion depth shall be at copper plating	
		portion for P.C.B. terminal after mounting.	
		Thickness of P.C. board : 1.8 mm	
R P	urability		
4. L	Iteas	Test conditions	Criterion
.1	Operating life	Switch shall be operated 10,000 cycles at 15~20 cycles/minute without	Contact resistance (Ites 4.1):
	without load	load.	_40 mQ MAX
			Insulation resistance (Item 4.2)
i			10 HO HIN
			Voltage proof (Item 4.3) :
		•	Apply 500 V AC for 1 minute.
			Ho dielectric breakdown shall occu
			Operating force (Item 5.1):
			Vithin 18 x of specified value
- 1			No abnormalities shall be recognized
			in appearance and construction.
.2	Operating life	Switch shall be operated 10,000 cycles at 15-20 cycles/sinute with	Contact resistance (Item 4.1) :
	with load	30 V DC O.1 A. (Resistive load)	<u>40</u> =Ω HAX
			Insulation resistance (Item 4.2):
			<u>10</u> но нін .
			Voltage proof (Item 4.3) :
			Apply 500 V AC for 1 minute.
			No dielectric breakdown shall occur
		·	Operating force (Itea 5.1)
			Vithin ±18 * of specified value.
			Ho abnormalities shall be recognized in appearance and construction.
7 U	eather proof		to appearance and construction.
' '	Items	94 11-1	
.1	Cold proof	Test conditions After testing at -20±2°C for 98 hours, the switch shall be allowed to	Criterion Control Control
`-		stand under normal temperature and humidity conditions for 1 hour, and	40 = 0 MAX
J		then measurement shall be made within 1 hour.	
- 1		Vater drops shall be removed.	Insulation resistance (Item 4.2): 10 NO NIH
ı			Voltage proof (Itea 4.3) :
			Apply 500 V AC for 1 sinute.
			No dielectric breakdown shall occur
			No dielectric breakdown shall occur Operating force (Item 5.1) :
			Ho dielectric breakdown shall occu Operating force (Item 5.1): Within ±38 % of specified value
			Ho dielectric breakdown shall occu Operating force (Ites 5.1): Within ±38 % of specified value No abnormalities shall be recognized
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to	Ho dielectric breakdown shall occu Operating force (Item 5.1): Within ±38 % of specified value
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and	No dielectric breakdown shall occu Operating force (Item 5.1): Within ±18 % of specified value No abnormalities shall be recognized in appearance and construction.
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and	Ho dielectric breakdown shall occur Operating force (Item 5.1): Within \$\frac{128}{28}\$ % of specified value Ho abnormalities shall be recognized in appearance and construction. Contact resistance (Item 4.1): 40 mQ MAX Insulation resistance (Item 4.2):
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occur Operating force (Item 5.1): Within ±18 % of specified value Ho abnormalities shall be recognized in appearance and construction. Contact resistance (Item 4.1): 40 mg MAX Insulation resistance (Item 4.2): 10 MΩ MIN
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occu Operating force (Item 5.1): Within ±18 X of specified value No abnormalities shall be recognized in appearance and construction. Contact resistance (Item 4.1): 40 ±2 MAX Insulation resistance (Item 4.2): 10 MΩ MIN Voltage proof (Item 4.3):
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occu Operating force (Item 5.1): Within ±18 X of specified value No abnormalities shall be recognized in appearance and construction. Contact resistance (Item 4.1): 40 μΩ MAX Insulation resistance (Item 4.2): 10 ΜΩ MIN Voltage proof (Item 4.3): Apply 500 V AC for 1 minute.
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occu Operating force (Item 5.1): Within ±18 X of specified value No abnormalities shall be recognized in appearance and construction. Contact resistance (Item 4.1): 40 μΩ ΜΑΧ Insulation resistance (Item 4.2): 10 ΜΩ ΜΙΝ Voltage proof (Item 4.3): Apply 500 V AC for 1 minute. Ho dielectric breakdown shall occur
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occur Operating force (Ites 5.1): Vithin ±38 x of specified value Ho abnaralities shall be recognized in appearance and construction. Contact resistance (Item 4.1): 40 aQ MAX Insulation resistance (Item 4.2): 10 MΩ MIH Voitage proof (Item 4.3): Apply 500 V AC for 1 minute. Ho dielectric breakdown shall occur Operating force (Item 5.1):
2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occu Operating force (Item 5.1): Vithin ±38
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occur Operating force (Item 5.1): Within ±38 x of specified value Ho abnormalities shall be recognized in appearance and construction. 40 mQ MAX Insulation resistance (Item 4.1): 40 mQ MAX Insulation resistance (Item 4.2): 10 MΩ HIN Voltage proof (Item 4.3): Apply 500 V AC for 1 minute. Ho dielectric breakdown shall occur Operating force (Item 5.1): Within ±38 x of specified value Ho abnormalities shall be recognized
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occur Operating force (Item 5.1): Vithin ±38 x of specified value No abnaralities shall be recognized in appearance and construction. Contact resistance (Item 4.1): 40
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occu Operating force (Item 5.1): Vithin ±38
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.	Ho dielectric breakdown shall occur Operating force (Item 5.1): Vithin ±38
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour. APPD. CHKD. DSGD.	Ho dielectric breakdown shall occu Operating force (Ites 5.1): Vithin ±18
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour. APPD. CHKD. DSGD.	Ho dielectric breakdown shall occur Operating force (Item 5.1): Within ±18
.2	Dry heat	After testing at 85±2°C for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour. APPD. CHKD. DSGD.	No dielectric breakdown shall occur Operating force (Ites 5.1): Vithin ±18

			(Push)
SP	PH-S-501	SPPH1 PRODUCT SPECIFICATIONS	
	lters	Test conditions	Criterian
7.3	Damp heat	After testing at 40±2°C and 90~95XEH for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions	Contact resistance (Item 4.1) : 40 mg HAX
		for 1 hour, and measurement shall be made within 1 hour after that. Water drops shall be removed.	Insulation resistance (Item 4.2): 10 NO NIN Voltage proof (Item 4.3):
,	<u>, </u>	-	Apply 500 V AC for 1 minute. Ho dielectric breakdown shall occur.
			Operating force (Item 5.1): Within ±30 X of specified value. No abnormalities shall be recognized
7.4	Salt mist	Switch shall be chacked after following test.	in appearance and construction. No remarkable corrosion shall be
		(1) Temperature: 35±2°C (2) Salt solution: 5±1% (Solids by weight) (3) Purstion: 24±1 h	recognized in metal part.
		After the test, salt deposit shall be removed in running water.	
7.5	Temperature cycling	After 5 cycles of following conditions, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and	Contact resistance (Item 4.1) : 40 mΩ MAX
		measurement shall be made within 1 hour after that. Vater drops shall be removed.	Insulation resistance (Item 4.2):
	•	70±2℃	Voltage proof (Item 4.3) : Apply 500 V AC for 1 minute. No dielectric breakdown shall occur.
			Operating force (Item 5.1): Vithin <u>+38</u> X of specified value.
	•	Normal	No abnormalities shall be recognized
ļ		temperature	in appearance and construction.
		-25±3°C 30 30 30 ain	
		10~15 10~15 nin	
		nin 1 cycle	
7.6	Damp heat with load	DC voltage 1.5 times as such as rated voltage shall be applied continuously between adjacent terminal at 80±2°C and 90~95%RH. After	Insulation resistance (50V DC):
	(Silver migration)	500 hours testing, switch shall be allowed to stand under normal temperature and humidity condition for 1 hour, and measurement shall be sade within 1 hour after that.	Voltage proof : Apply 100V AC for 1 minute. Bo dielectric
		Voter drops shall be removed.	breakdown shall occur.

Precaution in use

- 1. Note that if the load is applied to the terminals during soldering they might suffer deformation and defects in electrical
- performance.

 2. Use of water-soluble soldering flux shall be avoided because it may cause corrosion of the switch.
- 3. The knob should be mounted or demounted after single-lock releasing. If attempted under single locked condition, the single-acting mechanism may be damaged.

